

SHENZHEN YIXINWEI TECHNOLOGY CO.,LTD

6N70 Power MOSFET

6.0A, 700V N-CHANNEL POWER MOSFET

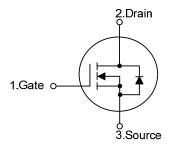
■ DESCRIPTION

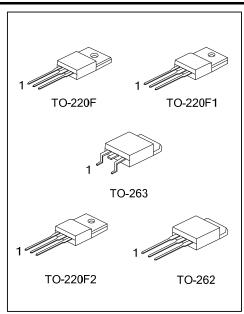
The Yixin **6N70** is an N-channel mode power MOSFET using's advanced technology to provide customers with a minimum on-state resistance, high switching speed, low gate charge and low input capacitance.

The Yixin **6N70** is universally applied in high efficiency switch mode power supply.

■ FEATURES

- * $R_{DS(ON)}$ <1.8 Ω @ V_{GS} =10V, I_{D} =3A
- * High switching speed
- SYMBOL

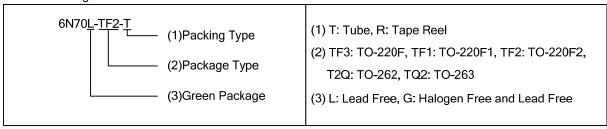




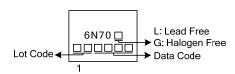
ORDERING INFORMATION

Ordering Number		Daalaaaa	Pin Assignment			De alsia a	
Lead Free	Halogen Free	Package	1	2	3	Packing	
6N70L-TF1-T	6N70G-TF1-T	TO-220F1	G	D	S	Tube	
6N70L-TF2-T	6N70G-TF2-T	TO-220F2	G	D	S	Tube	
6N70L-TF3-T	6N70G-TF3-T	TO-220F	G	D	S	Tube	
6N70L-T2Q-T	6N70G-T2Q-T	TO-262	G	D	S	Tube	
6N70L-TQ2-T	6N70G-TQ2-T	TO-263	G	D	S	Tube	
6N70L-TQ2-R	6N70G-TQ2-R	TO-263	G	D	S	Tape Reel	

Note: Pin Assignment: G: Gate D: Drain S: Source



MARKING



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■ ABSOLUTE MAXIMUM RATINGS (unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT		
Drain-Source Voltage		V_{DSS}	700	V		
Gate-Source Voltage (Note 2)		V_{GSS}	±30	V		
	Continuous	T _C =25°C	I _D	6	Α	
Drain Current		T _C =100°C		3.8	Α	
	Pulsed		I _{DM}	24	Α	
Avalanche Current (N	lote 2)		I _{AR}	6	Α	
Ala	Single Pulsed (Note 3)		E _{AS}	582	mJ	
Avalanche Energy	Repetitive (Note 2)		E _{AR}	13	mJ	
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.5	V/ns		
		TO-220F1		40		
Power Dissipation		TO-220F2	-	42	14/	
		TO-220F		40	W	
		TO-262/ TO-263	Б	125		
TO-220F1 TO-220F2 TO-220F TO-262/TO-26		TO-220F1	P_D	0.22		
		TO-220F2		0.33	W/°C	
		TO-220F		0.32		
		TO-262/TO-263		1		
Junction Temperature		TJ	+150	°C		
Storage Temperature		T _{STG}	-55~+150	°C		

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature
- 3. L = 30mH, I_{AS} = 6A, V_{DD} = 50V, R_G = 27 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 6A$, di/dt $\le 140A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	62.5	°C/W
	TO-220F1 TO-220F2		2.9	°C/W
Junction to Case	TO-220F	$\theta_{ extsf{JC}}$	3.1	°C/W
	TO-262/TO-263		1.0	°C/W
	TO-263		1.0	°C/W

6N70 Power MOSFET

■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

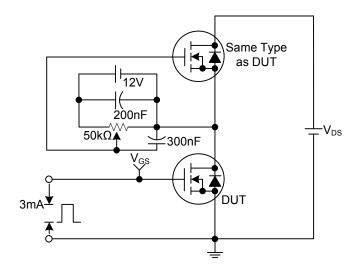
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	I _D =250μA, V _{GS} =0V	700			V
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_{J}$	I _D =250μA		0.79		V/°C
Paris Construction Const			V _{DS} =700V			25	μΑ
Drain-Source Leakage Current		I _{DSS}	V _{DS} =560V, T _C =125°C			250	μΑ
Gate-Source Leakage Current	Forward		V _{GS} =+30V, V _{DS} =0V			+100	nA
	Reverse	I_{GSS}	V_{GS} =-30V, V_{DS} =0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS}=V_{GS}$, $I_D=250\mu A$, $V_{DS}=5V$	2.0		4.0	V
Static Drain-Source On-State Re	esistance	R _{DS(ON)}	V _{GS} =10V, I _D =3A (Note 1)		1.5	1.8	Ω
DYNAMIC PARAMETERS							
Input Capacitance	Input Capacitance		-\/ -0\/ \/ -25\/		900	1200	pF
Output Capacitance		C _{ISS}	V _{GS} =0V, V _{DS} =25V, f=1.0MHz (Note 1, 2)		90	115	pF
Reverse Transfer Capacitance		C_{RSS}	1-1.0101112 (NOTE 1, 2)		18	55	pF
SWITCHING PARAMETERS							
Turn-ON Delay Time		$t_{D(ON)}$			40	70	ns
Rise Time		t_{R}	V_{DD} =350V, I_{D} =6A, R_{G} =11.5 Ω		65	90	ns
Turn-OFF Delay Time		$t_{D(OFF)}$	VDD-350V, ID-0A, NG-11:522		190	230	ns
Fall-Time		t_{F}			88	116	ns
Total Gate Charge		Q_G	V _{GS} =10V, V _{DS} =560V,		110	140	nC
Gate to Source Charge		Q_GS	I _D =6A (Note 1, 2)		9		nC
Gate to Drain Charge		Q_GD	ID-OA (Note 1, 2)		23.1		nC
SOURCE- DRAIN DIODE RATII	NGS AND CI	HARACTERIS'	TICS				
Maximum Body-Diode Continuous Current		Is	Integral reverse pn-diode in			6	Α
Maximum Body-Diode Pulsed Current		I _{SM}	the MOSFET			24	Α
(Note 3)			THE WIGOI ET			4	^
Drain-Source Diode Forward Voltage		V _{SD}	I _S =6A, V _{GS} =0V, T _J = 25°C			1.4	V
(Note 2)			15 071, VGS-0V, IJ - 20 0			1.7	'
Body Diode Reverse Recovery Time		t _{rr}	I _F =6A, dI _F /dt=100A/μs,		440		ns
Body Diode Reverse Recovery Charge		Q_{RR}	T _J = 25°C		4.05		μC

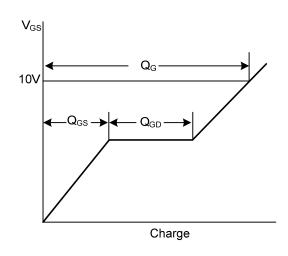
Notes: 1. Pulse Test: Pulse width ≤ 250µs, Duty cycle ≤ 2%

^{2.} Essentially independent of operating temperature

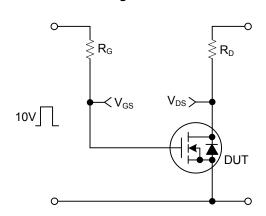
^{3.} Repetitive Rating: Pulse width limited by maximum junction temperature

■ TEST CIRCUITS AND WAVEFORMS

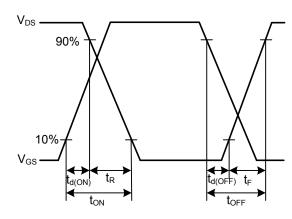




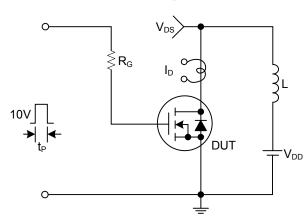
Gate Charge Test Circuit



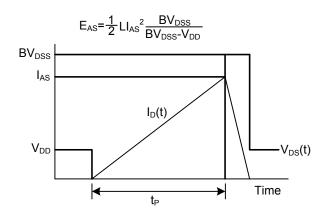
Gate Charge Waveforms



Resistive Switching Test Circuit



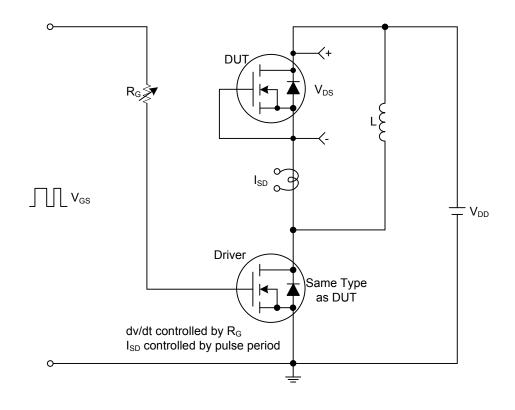
Resistive Switching Waveforms

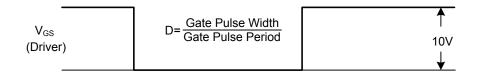


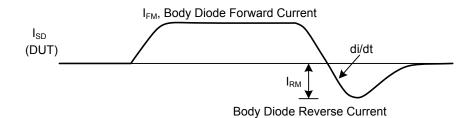
Unclamped Inductive Switching Test Circuit

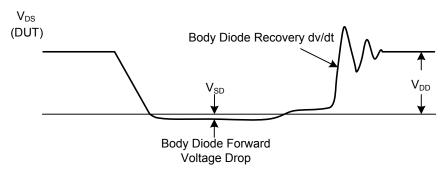
Unclamped Inductive Switching Waveforms

■ TEST CIRCUITS AND WAVEFORMS(Cont.)



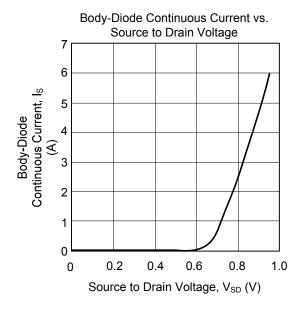






Peak Diode Recovery dv/dt Test Circuit and Waveforms

■ TYPICAL CHARACTERISTICS



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